



RESPONSE UNDER 37 C.F.R.
§1.116 EXPEDITED PROCEDURE
EXAMINING GROUP 2823

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Stephen L. Buchwalter, et al.

Examiner: Khiem D. Nguyen

Serial No: 09/782,494

Art Unit: 2823

Filed: February 13, 2001

Docket: YOR920000745US1 (14029)

For: BILAYER WAFER-LEVEL
UNDERFILL

Dated: December 23, 2003

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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RESPONSE UNDER 37 C.F.R. §1.116

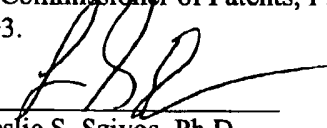
Sir:

In response to the Final Office Action dated September 24, 2003, applicants respectfully request that the following remarks be entered in the above-identified patent application.

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on December 23, 2003.

Dated: December 23, 2003


Leslie S. Szivos, Ph.D.

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